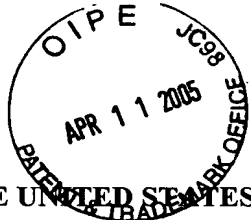


Docket No. 243433US2SX



IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Koji YAMAKAWA, et al.

SERIAL NO: 10/673,247

GAU: 1765

FILED: September 30, 2003

EXAMINER:

FOR: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the references cited in the attached International Search Report and listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.

Marvin J. Spivak

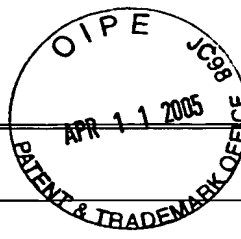
Registration No. 24,913

Joseph Scafetta, Jr.
Registration No. 26,803

Customer Number

22850

Tel. (703) 413-3000
Fax. (703) 413-2220
(OSMMN 05/03)

Form PTO 1449
(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY DOCKET NO.
243433US2SXSERIAL NO.
10/673,247

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT
Koji YAMAKAWA, et al.FILING DATE
September 30, 2003GROUP
1765

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	2003/0071294 A1	04/17/2003	Shan SUN, et al.			
	AB	6,423,592 B1	07/23/2002	Shan SUN			
	AC	6,756,262 B1	06/29/2004	Yoshitaka Nakamura, et al.			
	AD	6,610,549 B1	08/26/2003	Sanjeev AGGARWAL, et al.			
	AE	2002/0004249 A1	01/10/2002	Takashi KAWAKUBO			
	AF	5,889,299	03/30/1999	Kazuhide ABE, et al.			
	AG	2002/0154532 A1	10/24/2002	Hiromu MIYAZAWA, et al.			
	AH	2003/0058700 A1	03/27/2003	Rainer BRUCHHAUS, et al.			
	AI	5,650,362	07/22/1997	Keiichi NASHIMOTO			
	AJ	2003/0128570 A1	07/10/2003	Masahiro TANAKA, et al.			
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO	2001-144266	05/25/2001	Japan (with English Abstract and corr. US 6,756,262)		X
	AP	WO 03/021656 A2	03/13/2003	WIPO		
	AQ	EP 1 039 525 A1	09/27/2000	Europe		
	AR					
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	<input type="checkbox"/> Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.